

- ★ 100% EAS Guaranteed
- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

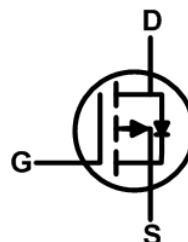
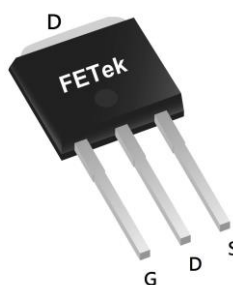
**Product Summary**


| BVDSS | RDSON | ID   |
|-------|-------|------|
| -30V  | 15mΩ  | -45A |

**Description**

The FKR3105 is the high cell density trenched P-ch MOSFETs, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The FKR3105 meet the RoHS and Green Product requirement 100% EAS guaranteed with full function reliability approved.

**TO251 Pin Configuration**

**Absolute Maximum Ratings**

| Symbol                 | Parameter                                              | Rating     |              | Units |
|------------------------|--------------------------------------------------------|------------|--------------|-------|
|                        |                                                        | 10s        | Steady State |       |
| $V_{DS}$               | Drain-Source Voltage                                   | -30        |              | V     |
| $V_{GS}$               | Gate-Source Voltage                                    | ± 25       |              | V     |
| $I_D@T_C=25^{\circ}C$  | Continuous Drain Current, $V_{GS}$ @ -10V <sup>1</sup> | -45        |              | A     |
| $I_D@T_C=100^{\circ}C$ | Continuous Drain Current, $V_{GS}$ @ -10V <sup>1</sup> | -30        |              | A     |
| $I_D@T_A=25^{\circ}C$  | Continuous Drain Current, $V_{GS}$ @ -10V <sup>1</sup> | -15        | -9.6         | A     |
| $I_D@T_A=70^{\circ}C$  | Continuous Drain Current, $V_{GS}$ @ -10V <sup>1</sup> | -12        | -7.7         | A     |
| $I_{DM}$               | Pulsed Drain Current <sup>2</sup>                      | -150       |              | A     |
| EAS                    | Single Pulse Avalanche Energy <sup>3</sup>             | 125        |              | mJ    |
| $I_{AS}$               | Avalanche Current                                      | -50        |              | A     |
| $P_D@T_C=25^{\circ}C$  | Total Power Dissipation <sup>4</sup>                   | 45         |              | W     |
| $P_D@T_A=25^{\circ}C$  | Total Power Dissipation <sup>4</sup>                   | 5          | 2.0          | W     |
| $T_{STG}$              | Storage Temperature Range                              | -55 to 150 |              | °C    |
| $T_J$                  | Operating Junction Temperature Range                   | -55 to 150 |              | °C    |

**Thermal Data**

| Symbol          | Parameter                                                  | Typ. | Max. | Unit |
|-----------------|------------------------------------------------------------|------|------|------|
| $R_{\theta JA}$ | Thermal Resistance Junction-Ambient <sup>1</sup>           | ---  | 62   | °C/W |
| $R_{\theta JA}$ | Thermal Resistance Junction-Ambient <sup>1</sup> (t ≤ 10s) | ---  | 25   | °C/W |
| $R_{\theta JC}$ | Thermal Resistance Junction-Case <sup>1</sup>              | ---  | 2.8  | °C/W |

**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**

| Symbol                       | Parameter                                      | Conditions                                                    | Min. | Typ.    | Max.      | Unit                |
|------------------------------|------------------------------------------------|---------------------------------------------------------------|------|---------|-----------|---------------------|
| $BV_{DSS}$                   | Drain-Source Breakdown Voltage                 | $V_{GS}=0V$ , $I_D=-250\mu A$                                 | -30  | ---     | ---       | V                   |
| $\Delta BV_{DSS}/\Delta T_J$ | BVDSS Temperature Coefficient                  | Reference to $25^\circ\text{C}$ , $I_D=-1mA$                  | ---  | -0.0232 | ---       | $V/^\circ\text{C}$  |
| $R_{DS(ON)}$                 | Static Drain-Source On-Resistance <sup>2</sup> | $V_{GS}=-10V$ , $I_D=-30A$                                    | ---  | ---     | 15        | $m\Omega$           |
|                              |                                                | $V_{GS}=-4.5V$ , $I_D=-15A$                                   | ---  | ---     | 25        |                     |
| $V_{GS(th)}$                 | Gate Threshold Voltage                         | $V_{GS}=V_{DS}$ , $I_D=-250\mu A$                             | -1.0 | ---     | -2.5      | V                   |
| $\Delta V_{GS(th)}$          | $V_{GS(th)}$ Temperature Coefficient           |                                                               | ---  | 4.6     | ---       | $mV/^\circ\text{C}$ |
| $I_{DSS}$                    | Drain-Source Leakage Current                   | $V_{DS}=-24V$ , $V_{GS}=0V$ , $T_J=25^\circ\text{C}$          | ---  | ---     | -1        | $\mu A$             |
|                              |                                                | $V_{DS}=-24V$ , $V_{GS}=0V$ , $T_J=55^\circ\text{C}$          | ---  | ---     | -5        |                     |
| $I_{GSS}$                    | Gate-Source Leakage Current                    | $V_{GS}=\pm 25V$ , $V_{DS}=0V$                                | ---  | ---     | $\pm 100$ | nA                  |
| $g_{fs}$                     | Forward Transconductance                       | $V_{DS}=-5V$ , $I_D=-30A$                                     | ---  | 30      | ---       | S                   |
| $R_g$                        | Gate Resistance                                | $V_{DS}=0V$ , $V_{GS}=0V$ , $f=1MHz$                          | ---  | 9       | ---       | $\Omega$            |
| $Q_g$                        | Total Gate Charge (-4.5V)                      | $V_{DS}=-15V$ , $V_{GS}=-4.5V$ , $I_D=-15A$                   | ---  | 22      | ---       | nC                  |
| $Q_{gs}$                     | Gate-Source Charge                             |                                                               | ---  | 8.7     | ---       |                     |
| $Q_{gd}$                     | Gate-Drain Charge                              |                                                               | ---  | 7.2     | ---       |                     |
| $T_{d(on)}$                  | Turn-On Delay Time                             | $V_{DD}=-15V$ , $V_{GS}=-10V$ , $R_G=3.3\Omega$<br>$I_D=-15A$ | ---  | 8       | ---       | ns                  |
| $T_r$                        | Rise Time                                      |                                                               | ---  | 73.7    | ---       |                     |
| $T_{d(off)}$                 | Turn-Off Delay Time                            |                                                               | ---  | 61.8    | ---       |                     |
| $T_f$                        | Fall Time                                      |                                                               | ---  | 24.4    | ---       |                     |
| $C_{iss}$                    | Input Capacitance                              | $V_{DS}=-15V$ , $V_{GS}=0V$ , $f=1MHz$                        | ---  | 2215    | ---       | pF                  |
| $C_{oss}$                    | Output Capacitance                             |                                                               | ---  | 310     | ---       |                     |
| $C_{rss}$                    | Reverse Transfer Capacitance                   |                                                               | ---  | 237     | ---       |                     |

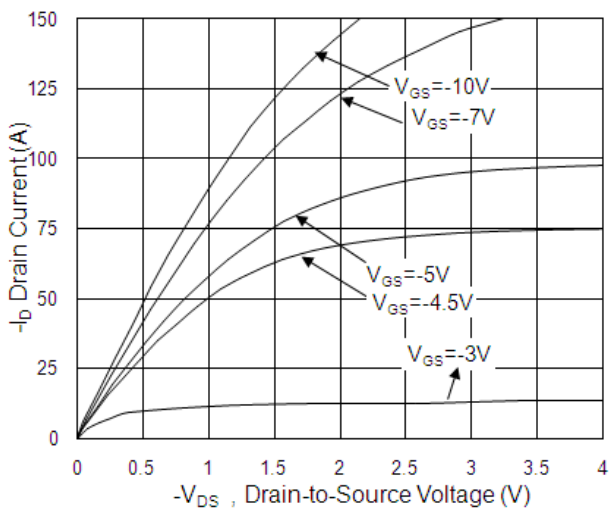
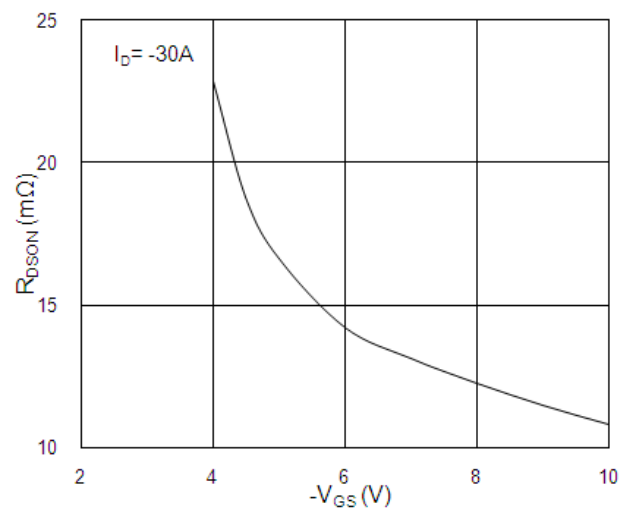
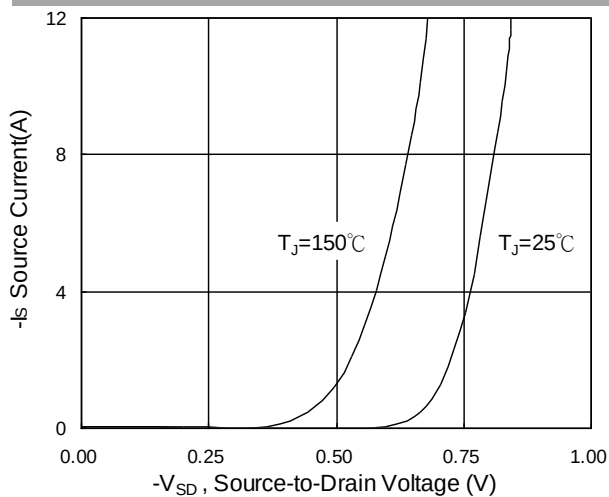
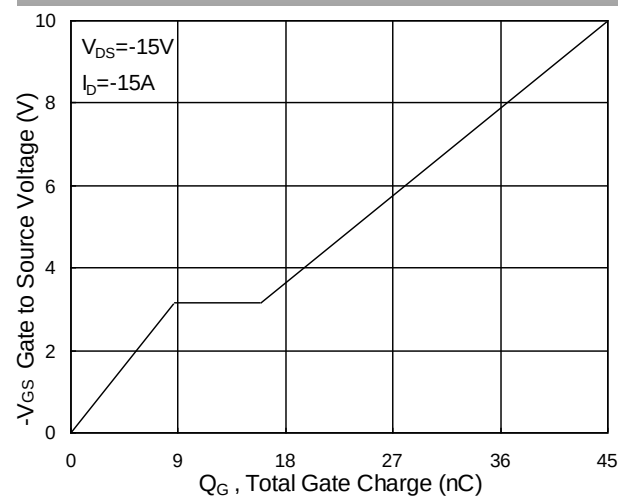
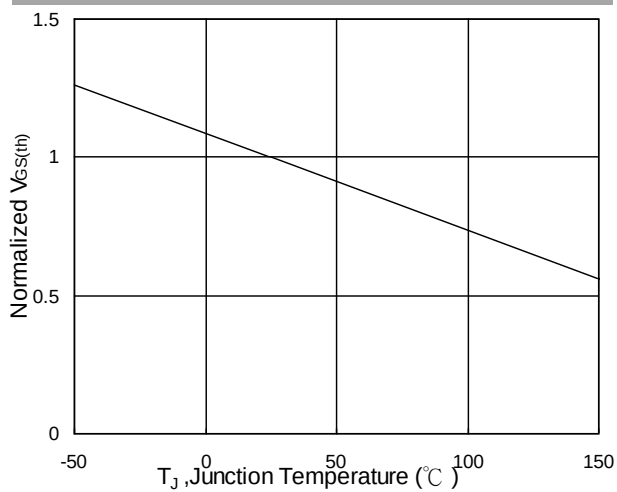
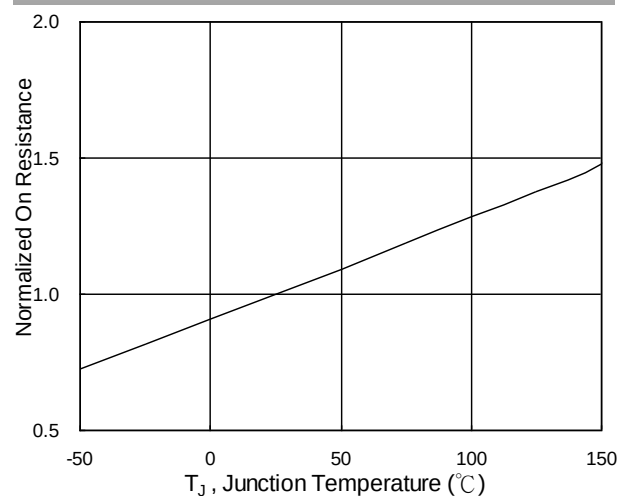
**Diode Characteristics**

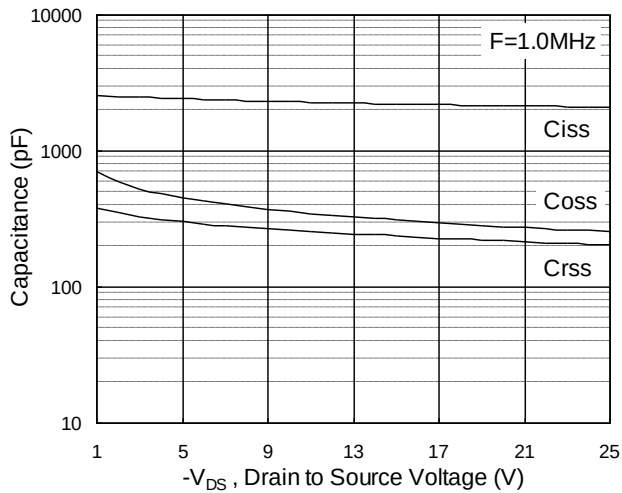
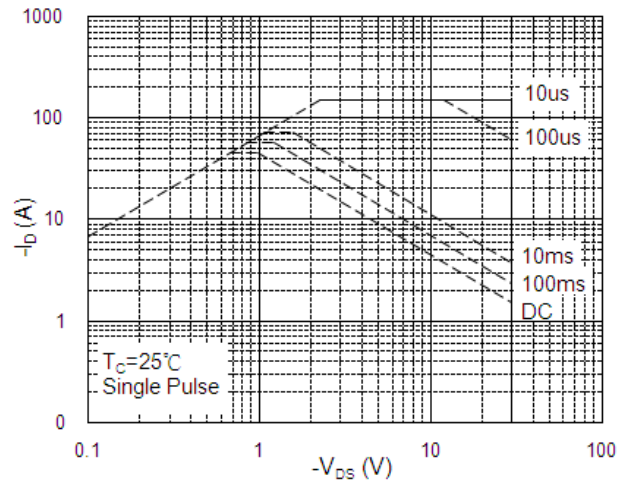
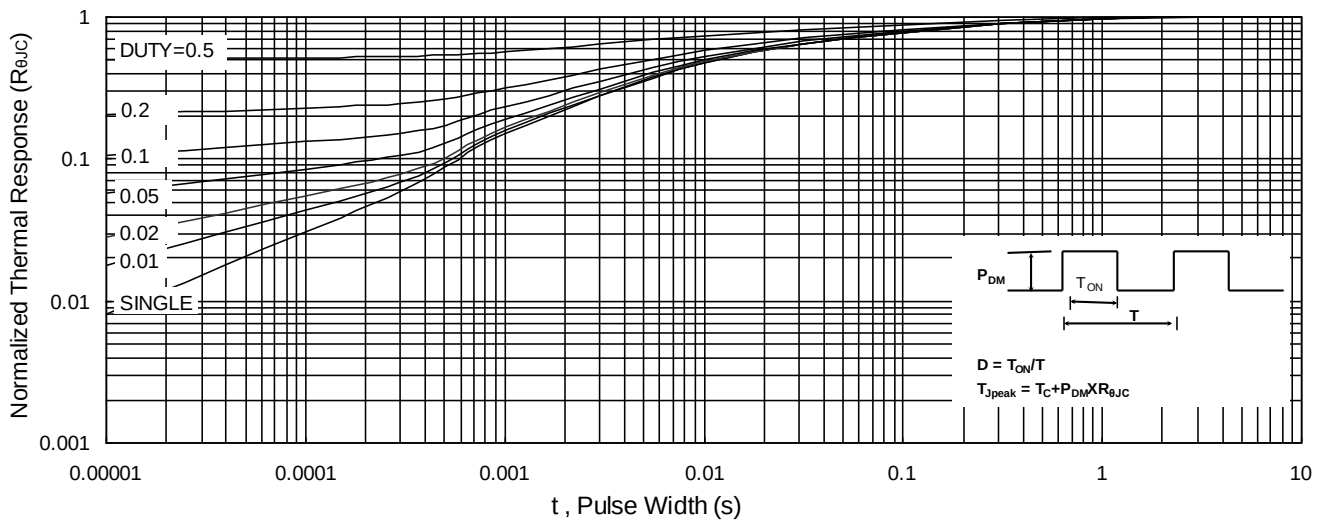
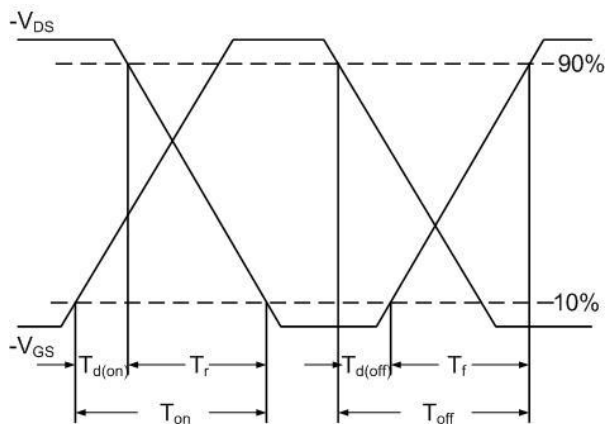
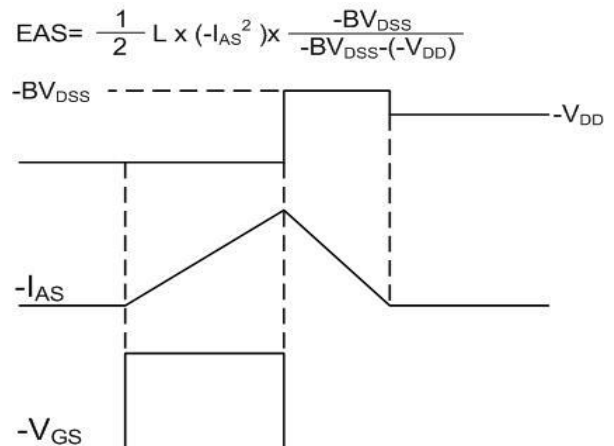
| Symbol   | Parameter                                | Conditions                                                  | Min. | Typ. | Max. | Unit |
|----------|------------------------------------------|-------------------------------------------------------------|------|------|------|------|
| $I_S$    | Continuous Source Current <sup>1,5</sup> | $V_G=V_D=0V$ , Force Current                                | ---  | ---  | -45  | A    |
| $I_{SM}$ | Pulsed Source Current <sup>2,5</sup>     |                                                             | ---  | ---  | -150 | A    |
| $V_{SD}$ | Diode Forward Voltage <sup>2</sup>       | $V_{GS}=0V$ , $I_S=-1A$ , $T_J=25^\circ\text{C}$            | ---  | ---  | -1   | V    |
| $t_{rr}$ | Reverse Recovery Time                    | $I_F=-15A$ , $dI/dt=100A/\mu s$ ,<br>$T_J=25^\circ\text{C}$ | ---  | 19   | ---  | nS   |
| $Q_{rr}$ | Reverse Recovery Charge                  | $T_J=25^\circ\text{C}$                                      | ---  | 9    | ---  | nC   |

Note :

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$
3. The EAS data shows Max. rating. The test condition is  $V_{DD}=-25V$ ,  $V_{GS}=-10V$ ,  $L=0.1mH$ ,  $I_{AS}=-50A$
4. The power dissipation is limited by  $150^\circ\text{C}$  junction temperature
5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.

## Typical Characteristics


**Fig.1 Typical Output Characteristics**

**Fig.2 On-Resistance vs. G-S Voltage**

**Fig.3 Forward Characteristics of Reverse**

**Fig.4 Gate-charge Characteristics**

**Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$** 

**Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$**


**Fig.7 Capacitance**

**Fig.8 Safe Operating Area**

**Fig.9 Normalized Maximum Transient Thermal Impedance**

**Fig.10 Switching Time Waveform**

**Fig.11 Unclamped Inductive Switching Waveform**